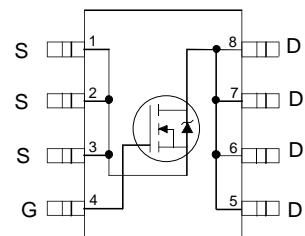


Features

- $V_{DS} (V) = 40V$
- $R_{DS(on)} < 7.5m\Omega$ ($V_{GS} = 10V$)
- $R_{DS(on)} < 9 m\Omega$ ($V_{GS} = 4.5V$)

Applications

- High Frequency DC-DC Converters with Synchronous Rectification
- Lead-Free



Top View

Benefits

- Ultra-Low Gate Impedance
- Very Low $R_{DS(on)}$ at 4.5V V_{GS}
- Fully Characterized Avalanche Voltage and Current

Absolute Maximum Ratings

Symbol	Parameter	Max.	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-to-Source Voltage	± 12	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	15	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	12	
I_{DM}	Pulsed Drain Current①	120	
$P_D @ T_A = 25^\circ C$	Maximum Power Dissipation③	2.5	W
$P_D @ T_A = 70^\circ C$	Maximum Power Dissipation③	1.6	W
	Linear Derating Factor	0.02	W/ $^\circ C$
T_J, T_{STG}	Junction and Storage Temperature Range	-55 to +150	$^\circ C$

Thermal Resistance

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient ④		50	$^\circ C/W$

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25^\circ C$, $L = 9.4mH$
 $R_G = 25\Omega$, $I_{AS} = 8.0A$.
- ③ Pulse width $\leq 400\mu s$; duty cycle $\leq 2\%$.
- ④ When mounted on 1 inch square copper board, $t < 10$ sec

Static @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	30			V	$V_{GS} = 0V, I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient		0.029		V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = 1\text{mA}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	6.0	7.5		$\text{m}\Omega$	$V_{GS} = 10V, I_D = 15\text{A}$ ④
		6.9	9			$V_{GS} = 4.5V, I_D = 12\text{A}$ ④
		10	2			$V_{GS} = 2.8V, I_D = 3.5\text{A}$ ④
$V_{GS(\text{th})}$	Gate Threshold Voltage	0.6		2.0	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
I_{DSS}	Drain-to-Source Leakage Current			20	μA	$V_{DS} = 24V, V_{GS} = 0V$
				100	μA	$V_{DS} = 24V, V_{GS} = 0V, T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage			200	nA	$V_{GS} = 12V$
	Gate-to-Source Reverse Leakage			-200	nA	$V_{GS} = -12V$

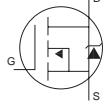
Dynamic @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
g_{fs}	Forward Transconductance	44			S	$V_{DS} = 10V, I_D = 15\text{A}$
Q_g	Total Gate Charge		37	56	nC	$I_D = 15\text{A}$
Q_{gs}	Gate-to-Source Charge		8.9	13		$V_{DS} = 24V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		13	20		$V_{GS} = 5.0V$ ③
Q_{oss}	Output Gate Charge		23	35		$V_{GS} = 0V, V_{DS} = 16V$
$t_{d(on)}$	Turn-On Delay Time		17		ns	$V_{DD} = 15V$
t_r	Rise Time		18			$I_D = 1.0\text{A}$
$t_{d(off)}$	Turn-Off Delay Time		51			$R_G = 6\Omega$
t_f	Fall Time		44			$V_{GS} = 4.5V$ ③
C_{iss}	Input Capacitance		3480		pF	$V_{GS} = 0V$
C_{oss}	Output Capacitance		870			$V_{DS} = 25V$
C_{rss}	Reverse Transfer Capacitance		100			$f = 1.0\text{MHz}$

Avalanche Characteristics

Symbol	Parameter	Typ.	Max.	Units
E_{AS}	Single Pulse Avalanche Energy ②		300	mJ
I_{AR}	Avalanche Current ①		15	A

Diode Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
I_s	Continuous Source Current (Body Diode)			2.5	A	MOSFET symbol showing the integral reverse p-n junction diode.
I_{SM}	Pulsed Source Current (Body Diode) ①			120		
V_{SD}	Diode Forward Voltage			1.2	V	$T_J = 25^\circ\text{C}, I_S = 2.5\text{A}, V_{GS} = 0V$ ③
t_{rr}	Reverse Recovery Time		64	96	ns	$T_J = 25^\circ\text{C}, I_F = 2.5\text{A}, V_R = 20V$
Q_{rr}	Reverse Recovery Charge		99	150	nC	$di/dt = 100\text{A}/\mu\text{s}$ ③

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

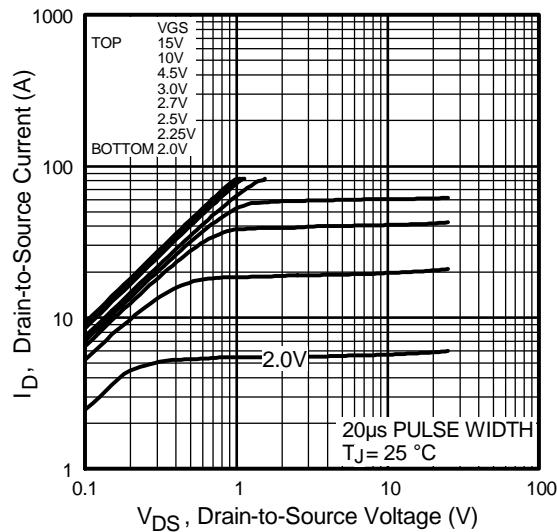


Fig 1. Typical Output Characteristics

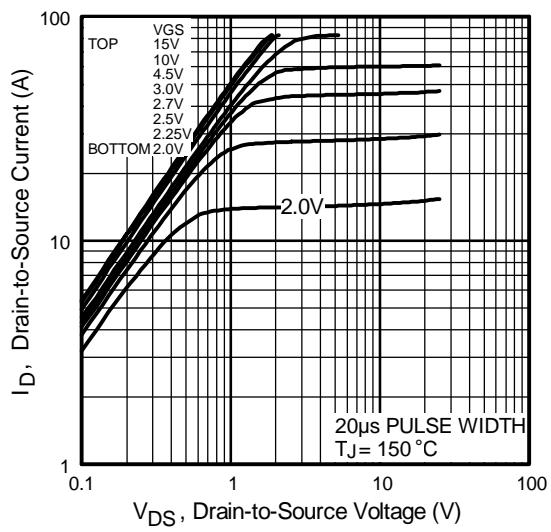


Fig 2. Typical Output Characteristics

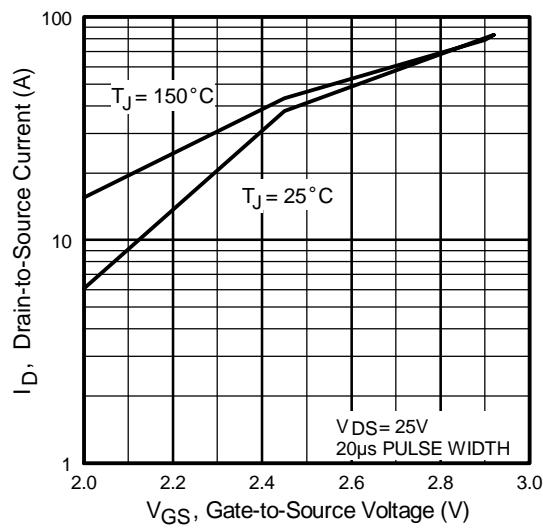


Fig 3. Typical Transfer Characteristics

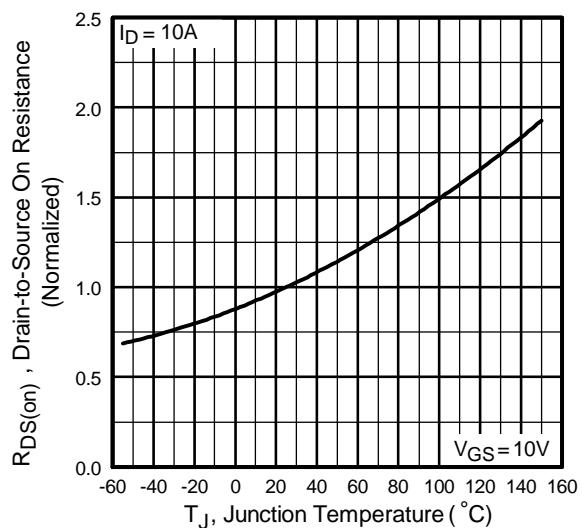


Fig 4. Normalized On-Resistance Vs. Temperature

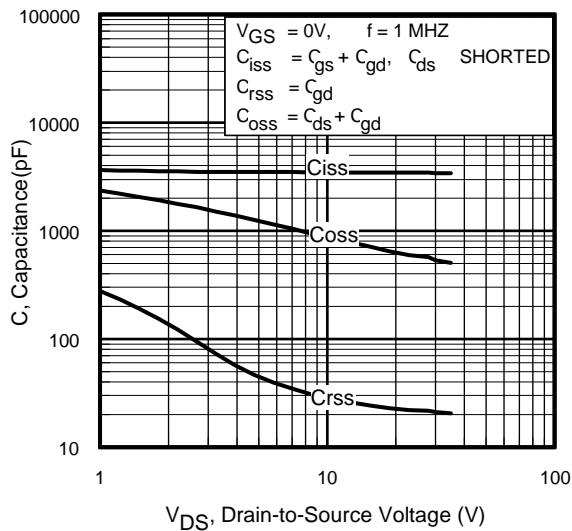
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

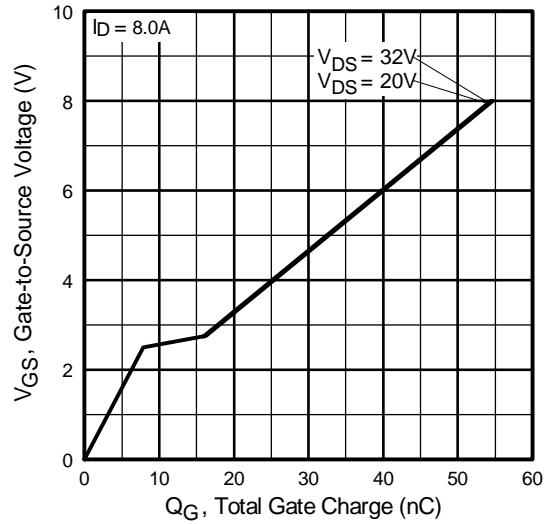


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

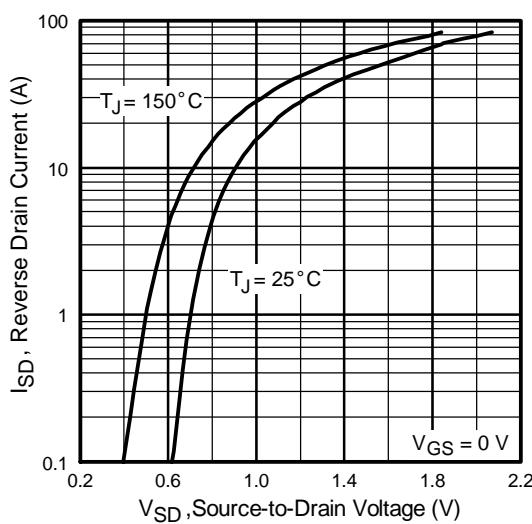


Fig 7. Typical Source-Drain Diode
Forward Voltage

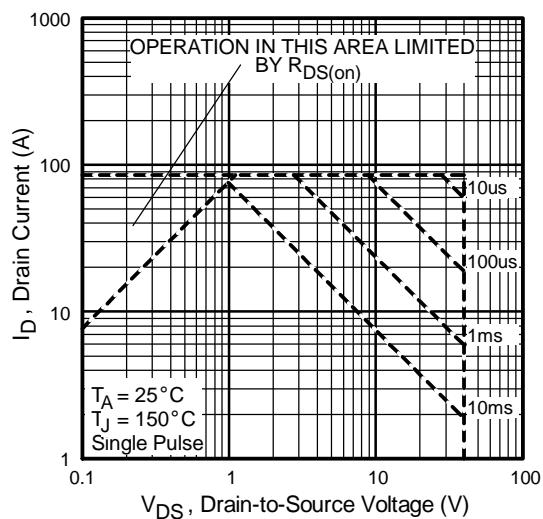
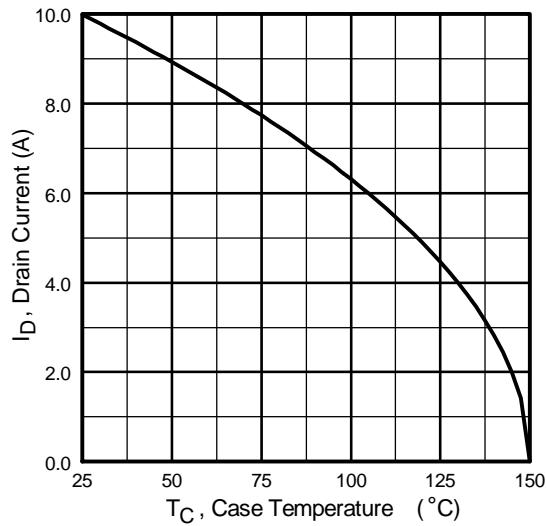
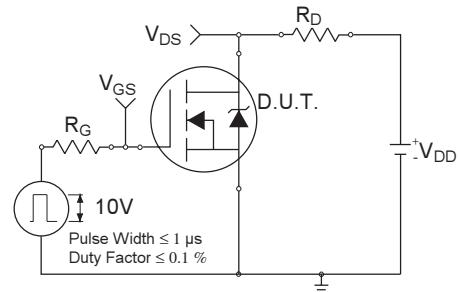
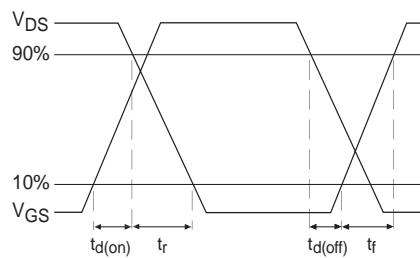
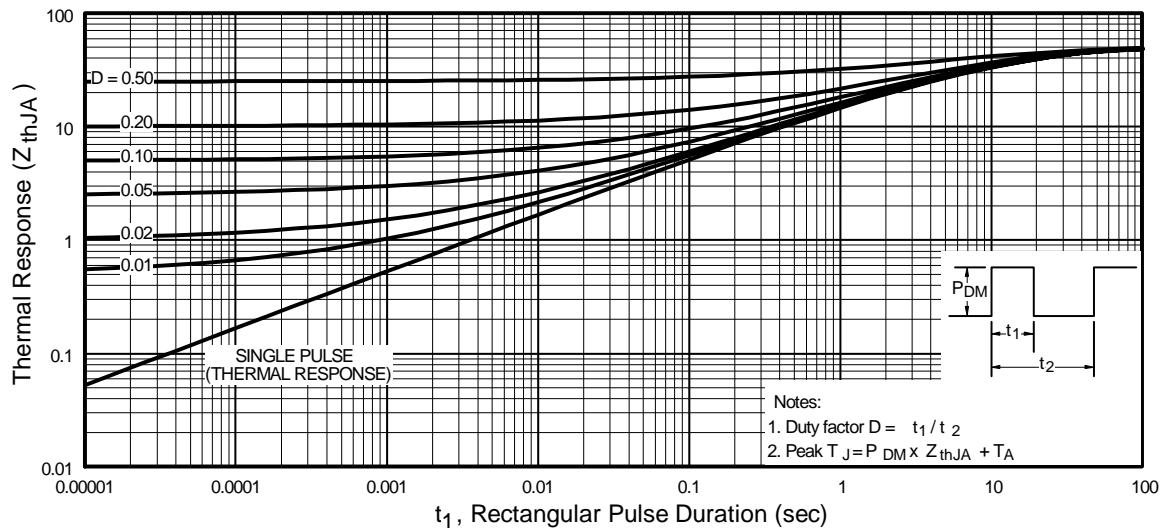


Fig 8. Maximum Safe Operating Area

**Fig 6.** On-Resistance Vs. Drain Current**Fig 10a.** Switching Time Test Circuit**Fig 10b.** Switching Time Waveforms**Fig 10.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

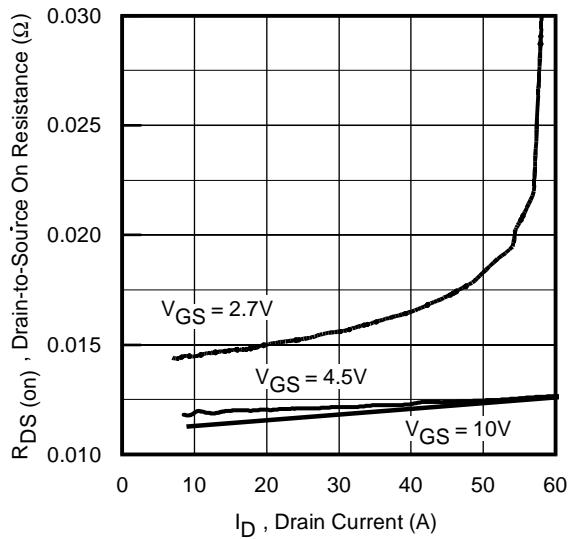


Fig 12. On-Resistance Vs. Drain Current

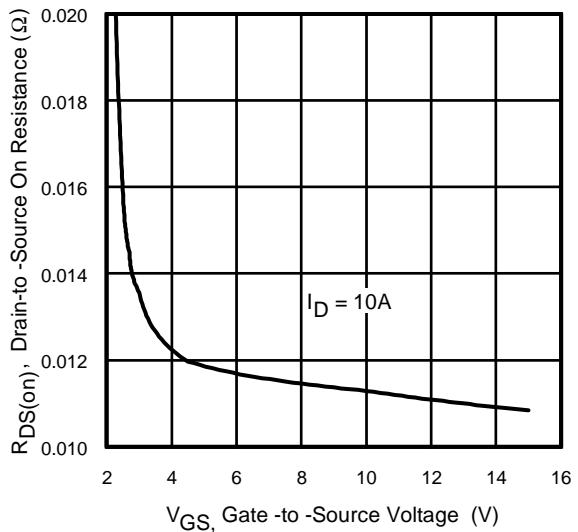


Fig 13. On-Resistance Vs. Gate Voltage

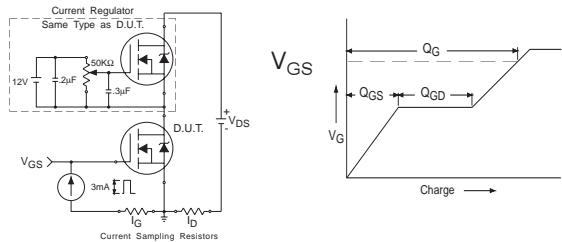


Fig 13a&b. Basic Gate Charge Test Circuit and Waveform

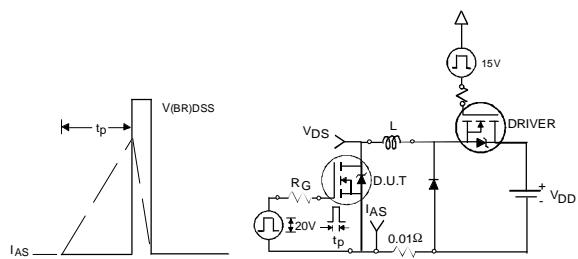


Fig 14a&b. Unclamped Inductive Test circuit and Waveforms

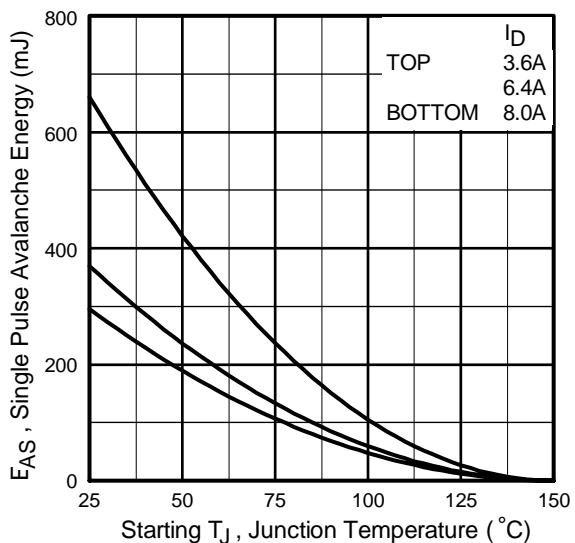
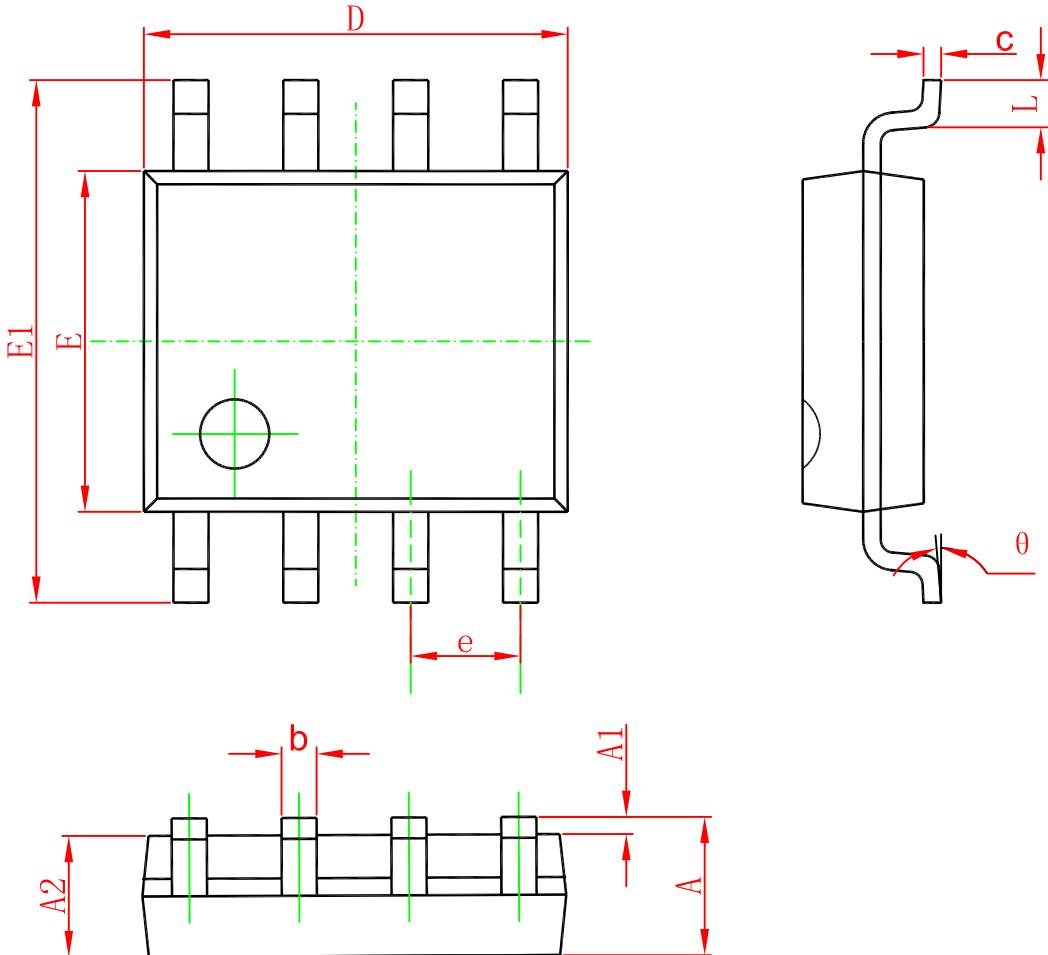


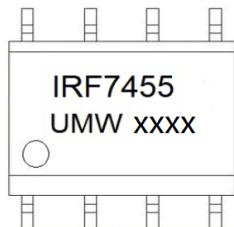
Fig 14c. Maximum Avalanche Energy Vs. Drain Current

SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Marking



Ordering information

Order code	Package	Baseqty	Deliverymode
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[C3M0021120D](#) [DMN6022SSD-13](#)